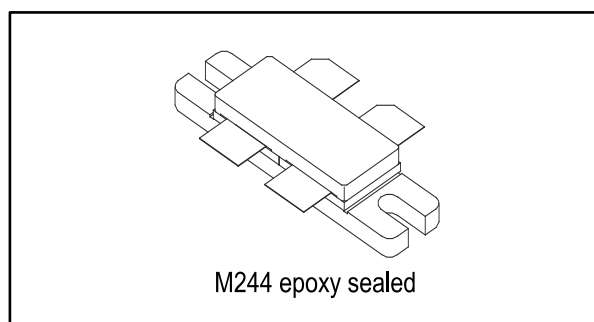
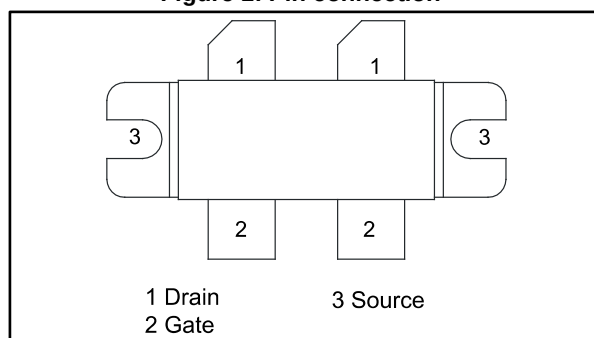


## HF/VHF/UHF RF power N-channel MOSFET

Datasheet - production data



**Figure 1: Pin connection**



### Features

- Gold metallization
- Excellent thermal stability
- Common source push-pull configuration
- $P_{OUT} = 300\text{ W min. with } 15\text{ dB gain @ } 175\text{ MHz}$

### Description

The SD2932 is a gold metallized N-channel MOS field-effect RF power transistor used for 50 V DC large signal applications up to 250 MHz.

**Table 1: Device summary**

| Order code | Marking               | Package | Packing |
|------------|-----------------------|---------|---------|
| SD2932W    | SD2932 <sup>(1)</sup> | M244    | Tube    |

#### Notes:

<sup>(1)</sup>For more details please refer to [Section 11: "Marking, packing and shipping specifications"](#).

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# 1 Electrical data

## 1.1 Maximum ratings

$T_{\text{CASE}} = 25\text{ }^{\circ}\text{C}$

Table 2: Absolute maximum ratings

| Symbol                      | Parameter                                                 | Value       | Unit               |
|-----------------------------|-----------------------------------------------------------|-------------|--------------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain source voltage                                      | 125         | V                  |
| $V_{\text{DGR}}$            | Drain-gate voltage ( $R_{\text{GS}} = 1\text{ M}\Omega$ ) | 125         | V                  |
| $V_{\text{GS}}$             | Gate-source voltage                                       | $\pm 40$    | V                  |
| $I_{\text{D}}$              | Drain current                                             | 40          | A                  |
| $P_{\text{DISS}}$           | Power dissipation                                         | 500         | W                  |
| $T_{\text{J}}$              | Max. operating junction temperature                       | +200        | $^{\circ}\text{C}$ |
| $T_{\text{STG}}$            | Storage temperature                                       | -65 to +150 | $^{\circ}\text{C}$ |

## 1.2 Thermal data

Table 3: Thermal data

| Symbol            | Parameter                           | Value | Unit                 |
|-------------------|-------------------------------------|-------|----------------------|
| $R_{\text{thJC}}$ | Junction-to-case thermal resistance | 0.35  | $^{\circ}\text{C/W}$ |

## 2 Electrical characteristics

$T_{CASE} = 25\text{ }^{\circ}\text{C}$

Table 4: Static

| Symbol                | Test conditions        |                          | Min. | Typ. | Max. | Unit          |
|-----------------------|------------------------|--------------------------|------|------|------|---------------|
| $V_{(BR)DSS}$         | $V_{GS} = 0\text{ V}$  | $I_{DS} = 100\text{ mA}$ | 125  |      |      | V             |
| $I_{DSS}$             | $V_{GS} = 0\text{ V}$  | $V_{DS} = 50\text{ V}$   |      |      | 50   | $\mu\text{A}$ |
| $I_{GSS}$             | $V_{GS} = 20\text{ V}$ | $V_{DS} = 0\text{ V}$    |      |      | 250  | nA            |
| $V_{GS(Q)}$           | $V_{DS} = 10\text{ V}$ | $I_D = 250\text{ mA}$    | 1.5  |      | 4    | V             |
| $V_{DS(ON)}$          | $V_{GS} = 10\text{ V}$ | $I_D = 10\text{ A}$      |      |      | 3.0  | V             |
| $G_{FS}$              | $V_{DS} = 10\text{ V}$ | $I_D = 5\text{ A}$       | 5    |      |      | mho           |
| $\Delta V_{GS}^{(1)}$ | $V_{DS} = 10\text{ V}$ | $I_D = 250\text{ mA}$    |      |      | 200  | mV            |
| $C_{ISS}$             | $V_{GS} = 0\text{ V}$  | $V_{DS} = 50\text{ V}$   |      | 480  |      | pF            |
| $C_{OSS}$             | $V_{GS} = 0\text{ V}$  | $V_{DS} = 50\text{ V}$   |      | 190  |      | pF            |
| $C_{RSS}$             | $V_{GS} = 0\text{ V}$  | $V_{DS} = 50\text{ V}$   |      | 18   |      | pF            |

**Notes:**

<sup>(1)</sup>Absolute  $V_{GS}$  difference between side 1 and side 2 of the device.

Table 5: Dynamic

| Symbol        | Test conditions        |                                                                                               | Min. | Typ. | Max. | Unit |
|---------------|------------------------|-----------------------------------------------------------------------------------------------|------|------|------|------|
| $P_{OUT}$     | $V_{DD} = 50\text{ V}$ | $I_{DQ} = 500\text{ mA}$ $f = 175\text{ MHz}$                                                 | 300  |      |      | W    |
| $G_{PS}$      | $V_{DD} = 50\text{ V}$ | $I_{DQ} = 500\text{ mA}$ $P_{OUT} = 300\text{ W}$<br>$f = 175\text{ MHz}$                     | 15   | 16   |      | dB   |
| $\eta_D$      | $V_{DD} = 50\text{ V}$ | $I_{DQ} = 500\text{ mA}$ $P_{OUT} = 300\text{ W}$<br>$f = 175\text{ MHz}$                     | 50   | 60   |      | %    |
| Load mismatch | $V_{DD} = 50\text{ V}$ | $I_{DQ} = 500\text{ mA}$ $P_{OUT} = 300\text{ W}$<br>$f = 175\text{ MHz}$<br>All phase angles | 5:1  |      |      | VSWR |

### 3 Impedance data

Figure 2: Impedance data

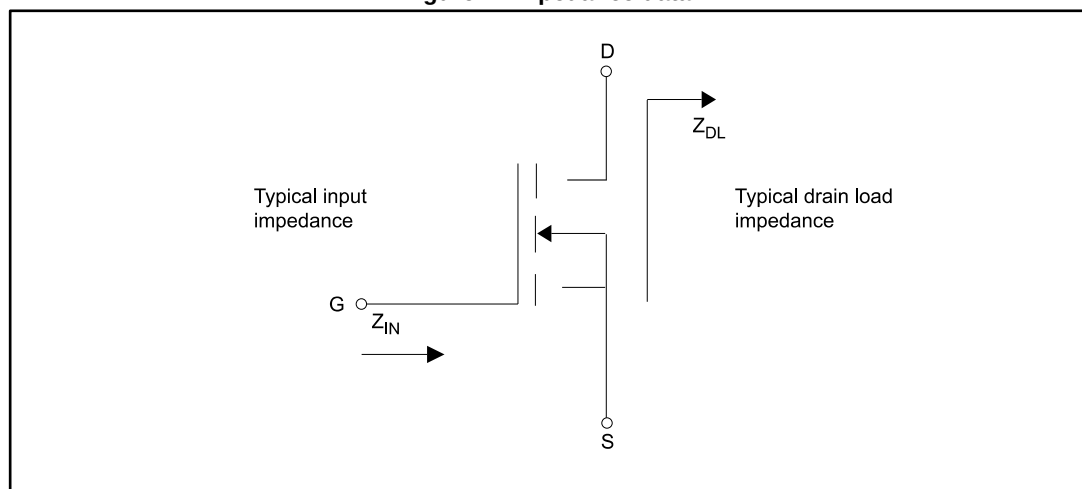


Table 6: Impedance data

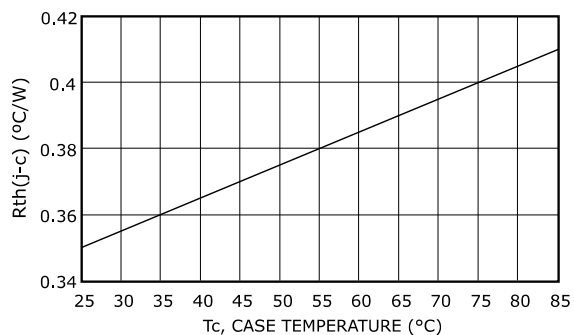
| f       | $Z_{IN}(\Omega)$ | $Z_{DL}(\Omega)$ |
|---------|------------------|------------------|
| 175 MHz | $0.92 - j 0.14$  | $3.17 + j 4.34$  |



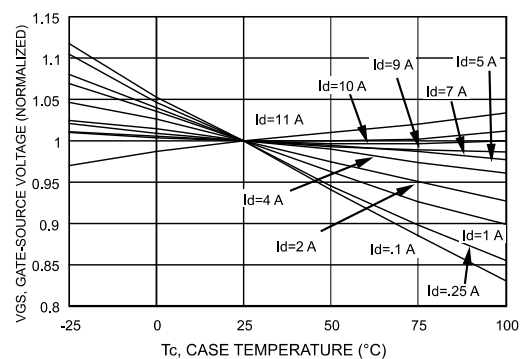
Measured gate-to-gate and drain-to-drain, respectively.

## 4 Typical performance

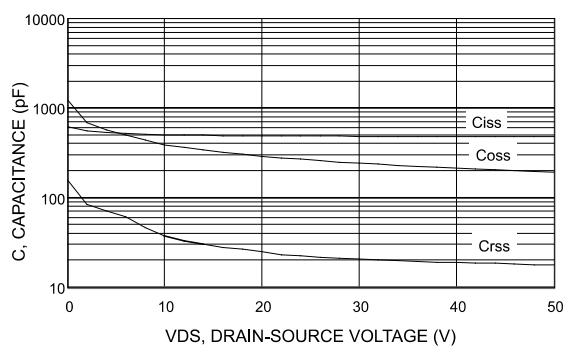
**Figure 3: Maximum thermal resistance vs. case temperature**



**Figure 4: Gate voltage vs. case temperature**



**Figure 5: Capacitance vs. drain-source voltage**



**Figure 6: Drain current vs. gate voltage**

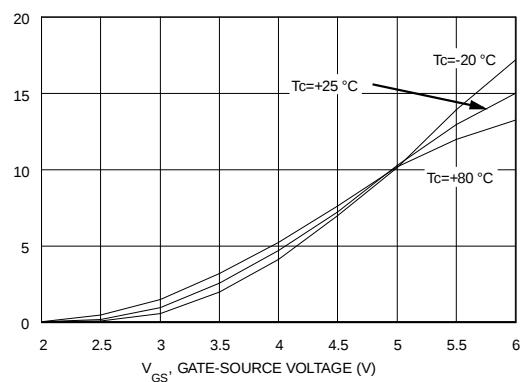


Figure 7: Maximum safe operating area

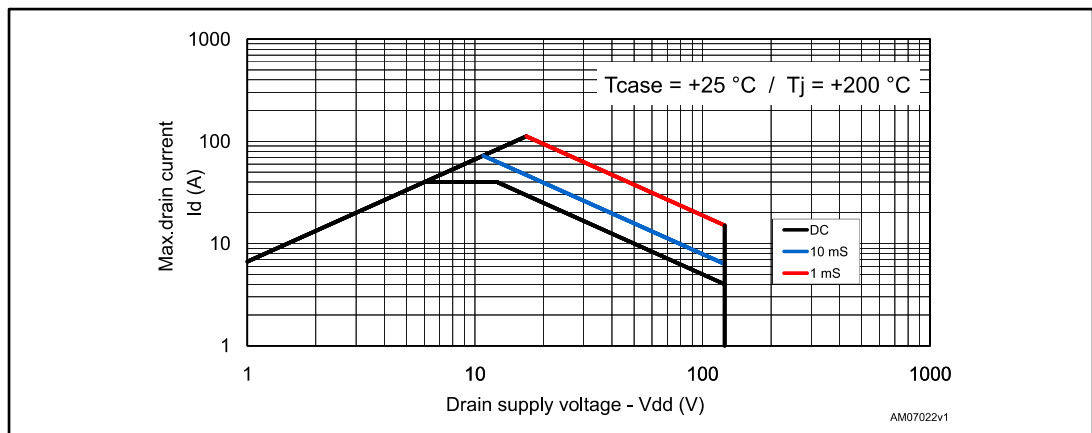


Figure 8: Transient thermal impedance

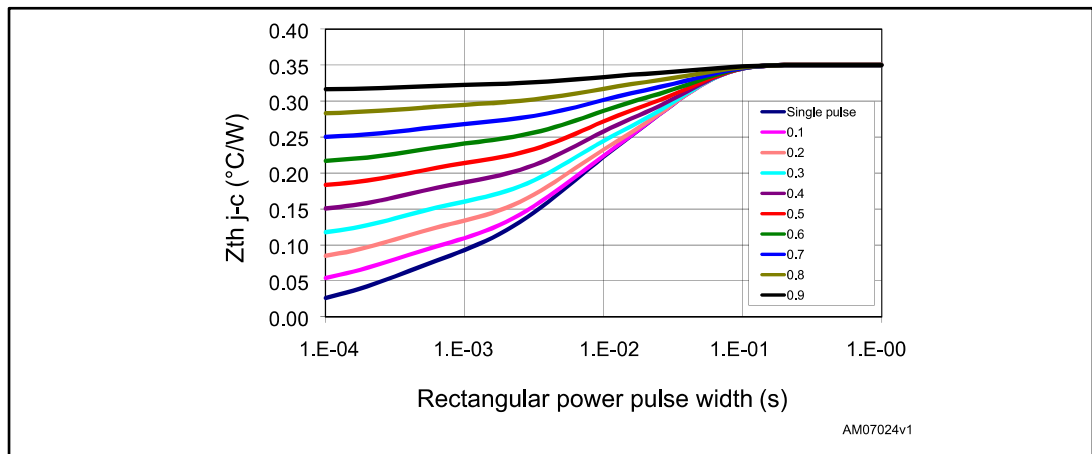
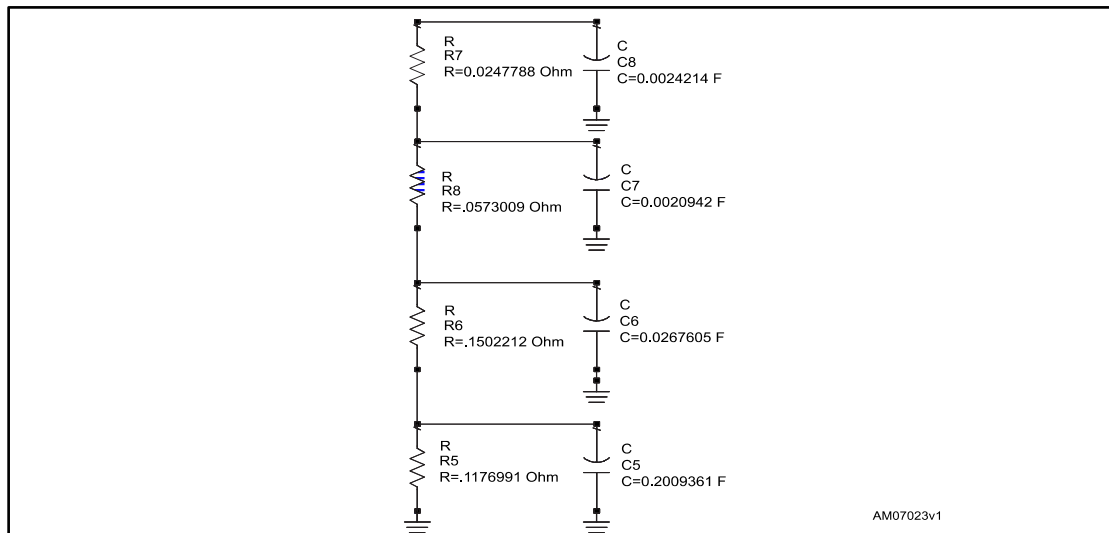


Figure 9: Transient thermal model



## 4.1 Typical performance (175 MHz)

Figure 10: Output power vs. input power

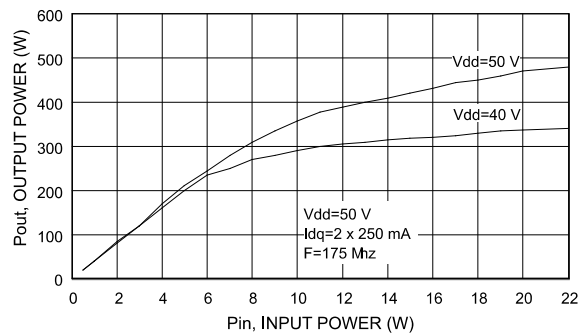
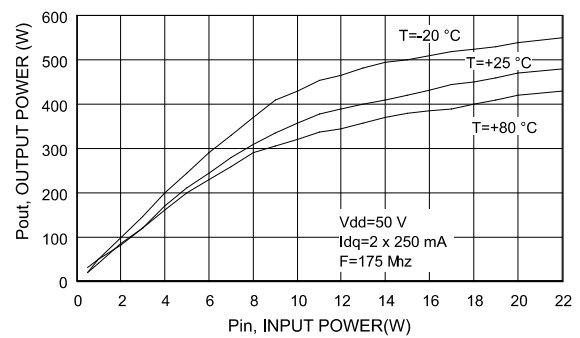
Figure 11: Output power vs. input power at different  $T_c$ 

Figure 12: Power gain vs. output power

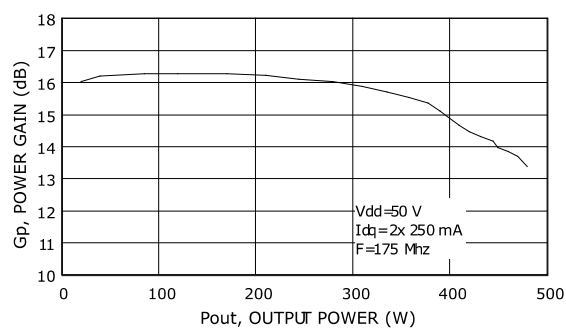


Figure 13: Efficiency vs. output power

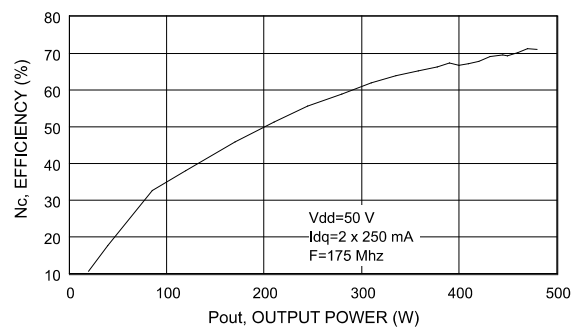


Figure 14: Output power vs. supply voltage

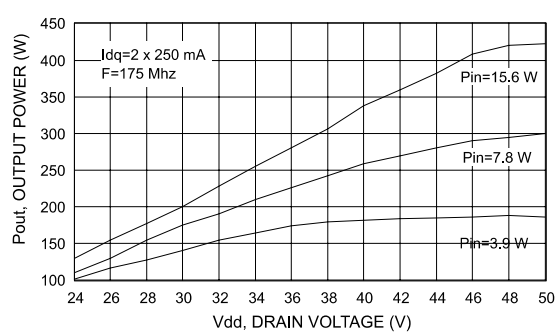
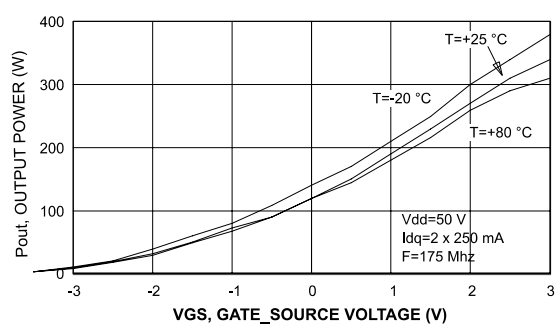


Figure 15: Output power vs. gate voltage



## 5 Test circuit (175 MHz)

Figure 16: 175 MHz production test circuit schematic

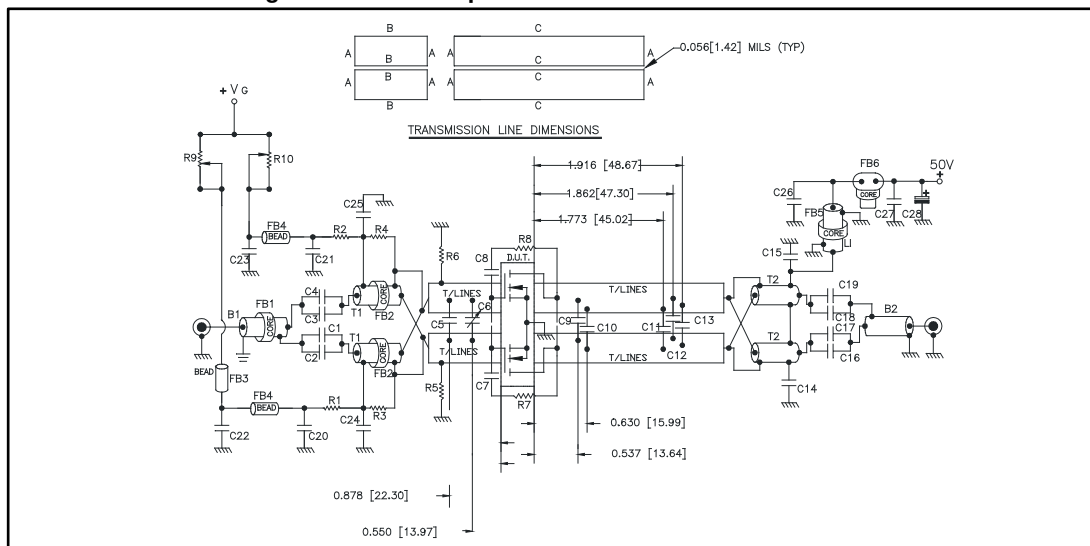


Table 7: 175 MHz test circuit part list

| Component                          | Description                                                                                        |
|------------------------------------|----------------------------------------------------------------------------------------------------|
| R1, R2, R5, R6                     | 470 Ohm 1 W, surface mount chip resistor                                                           |
| R3, R4                             | 360 Ohm 0.5 W, carbon comp. axial lead resistor or equivalent                                      |
| R7, R8                             | 560 Ohm 2 W, resistor 2 turn wire air-wound axial lead resistor                                    |
| R9, R10                            | 20 kOhm 3.09 W, 10 turn wirewound precision potentiometer                                          |
| C1, C4                             | 680 pF ATC 130B surface mount ceramic chip capacitor                                               |
| C2, C3, C7, C8, C17, C19, C20, C21 | 10000 pF ATC 200B surface mount ceramic chip capacitor                                             |
| C5                                 | 75 pF ATC 100B surface mount ceramic chip capacitor                                                |
| C6                                 | ST40 25 pF - 115 pF miniature variable trimmer                                                     |
| C9, C10                            | 47 pF ATC 100B surface mount ceramic chip capacitor                                                |
| C11, C12, C13                      | 43 pF ATC 100B surface mount ceramic chip capacitor                                                |
| C14, C15, C24, C25                 | 1200 pF ATC 700B surface mount ceramic chip capacitor                                              |
| C16, C18                           | 470 pF ATC 700B surface mount ceramic chip capacitor                                               |
| C22, C23                           | 0.1 $\mu$ F / 500 V surface mount ceramic chip capacitor                                           |
| C26, C27                           | 0.01 $\mu$ F / 500 V surface mount ceramic chip capacitor                                          |
| C28                                | 10 $\mu$ F / 63 aluminum electrolytic axial lead capacitor                                         |
| B1                                 | 50 Ohm RG316 O.D 0.076[1.93] L = 11.80[299.72] flexible coaxial cable 4 turns through ferrite bead |
| B2                                 | 50 Ohm RG-142B O.D 0.165[4.19] L = 11.80[299.72] flexible coaxial cable                            |

| Component | Description                                                                                                                                   |
|-----------|-----------------------------------------------------------------------------------------------------------------------------------------------|
| T1        | R.F. transformer 4:1, 25 Ohm O.D RG316-25 O.D 0.080[2.03] L = 5.90[149.86] flexible coaxial cable 2 turns through ferrite multi-aperture core |
| T2        | R.F. transformer 1:4, 25 Ohm semi-rigid coaxial cable O.D. 0.141[3.58] L = 5.90[149.86]                                                       |
| L1        | Inductor $\lambda$ 1/4 wave 50 Ohm O.D 0.165[4.19] L = 11.80 [299.72] flexible coaxial cable 2 turns through ferrite bead                     |
| FB1, FB5  | Shield bead                                                                                                                                   |
| FB2, FB6  | Multi-aperture core                                                                                                                           |
| FB3       | Multilayer ferrite chip bead (surface mount)                                                                                                  |
| FB4       | Surface mount EMI shield bead                                                                                                                 |
| PCB       | Woven glass reinforced PTFE microwave laminate 0.06", 1 oz EDCu, both sides, $\epsilon_r = 2.55$                                              |

## 6 Test circuit photomaster

Figure 17: 175 MHz test circuit photomaster

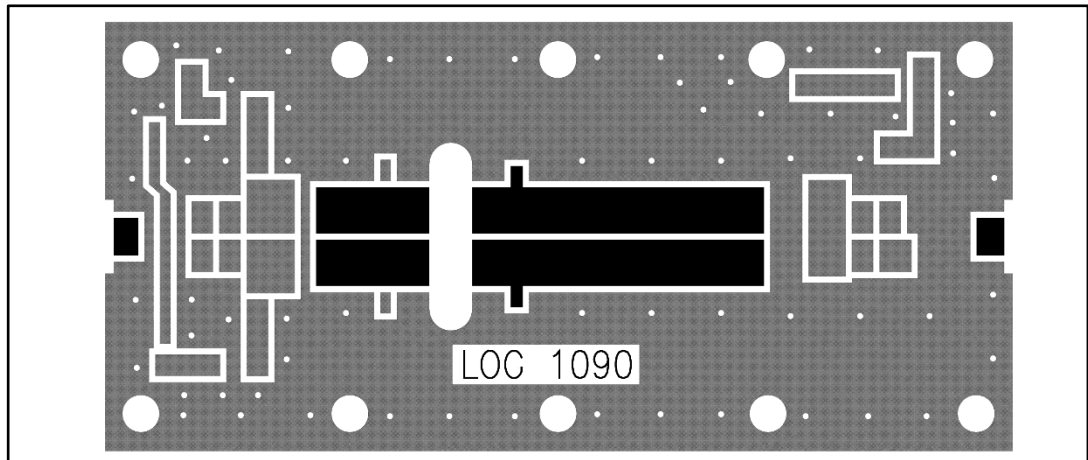
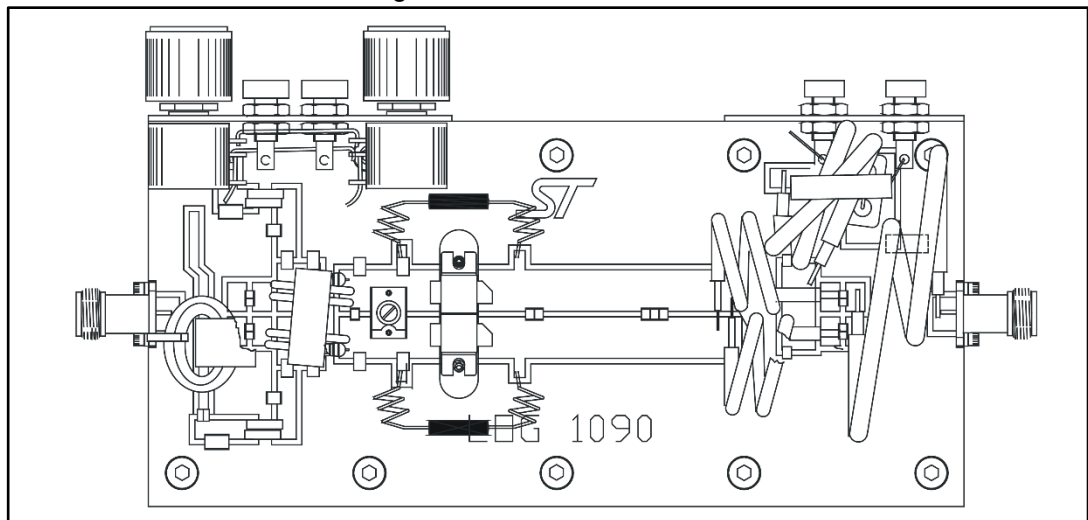


Figure 18: 175 MHz test fixture



## 7 Typical broadband data (175-230 MHz)

Figure 19: Input power vs. frequency

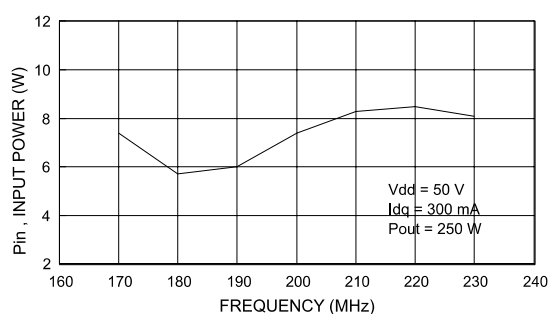


Figure 20: Power gain vs. frequency

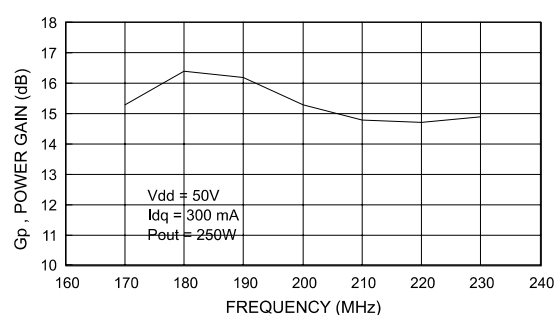


Figure 21: Efficiency vs. frequency

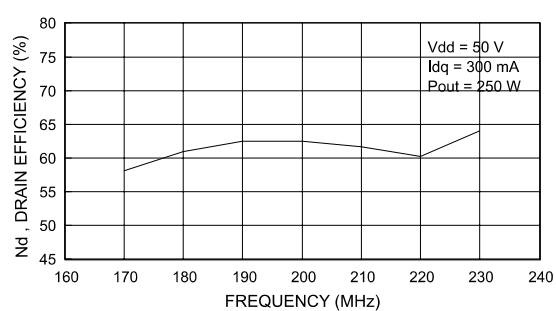


Figure 22: Return loss vs. frequency

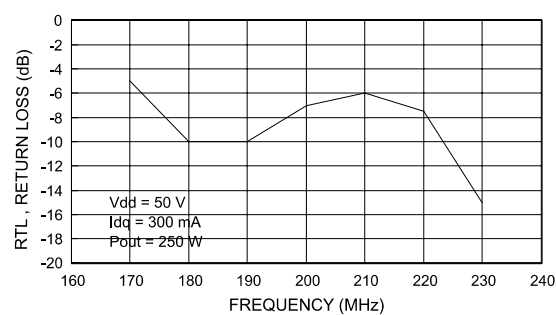
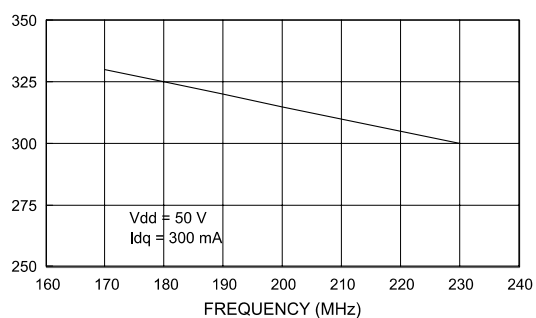


Figure 23: 1 dB compression point vs. frequency



## 8 Test circuit 175 - 230 MHz

Figure 24: 175 - 230 MHz test circuit layout (engineering fixture)

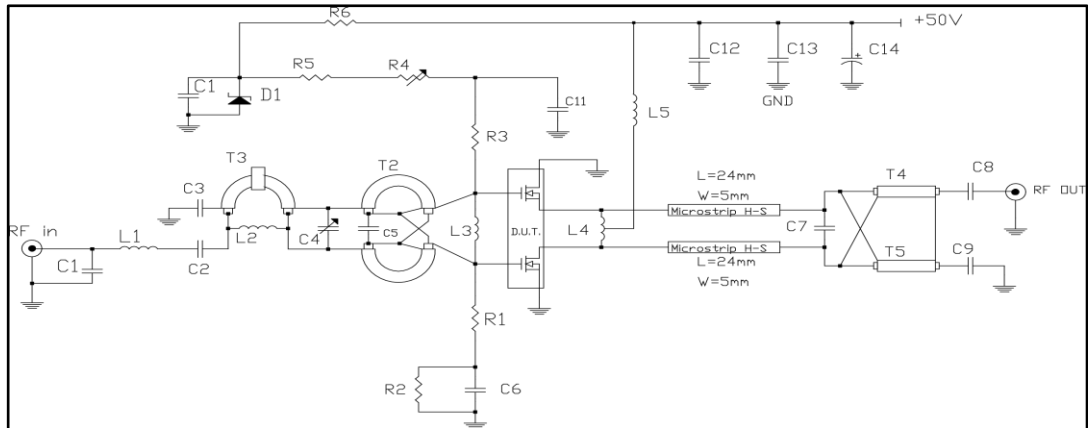
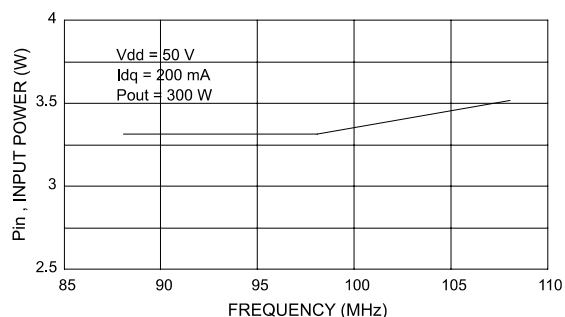
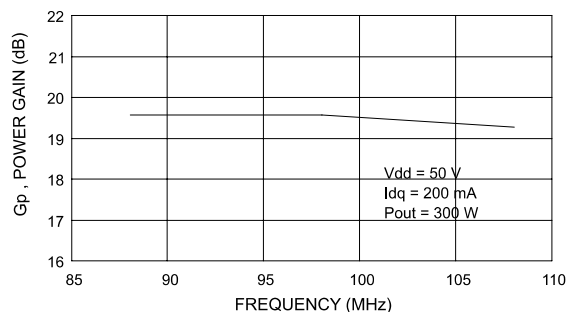
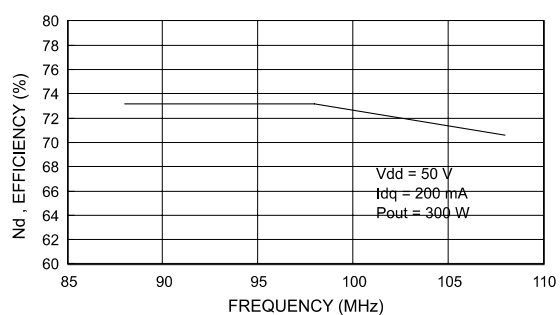
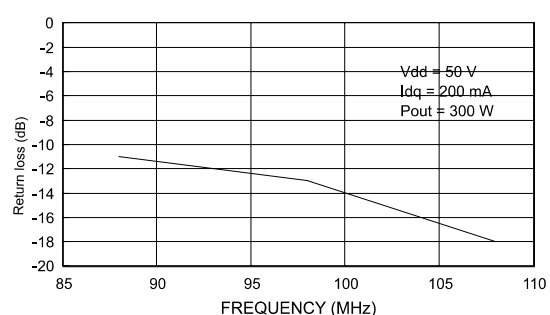
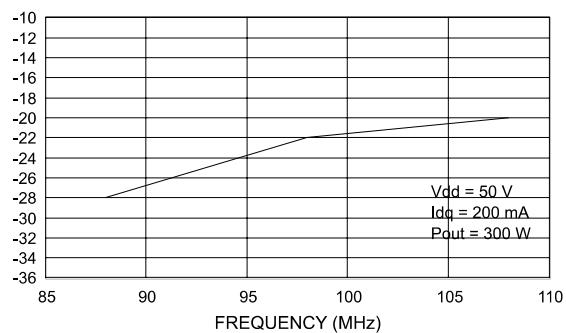
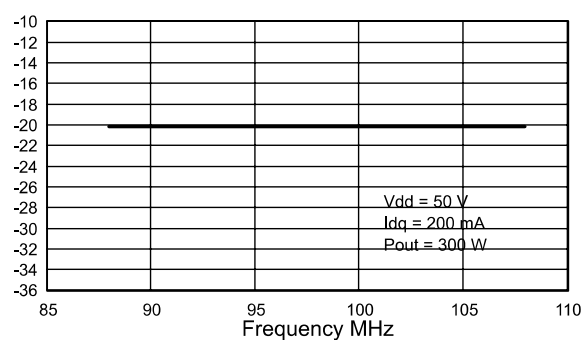


Table 8: 175 - 230 MHz circuit layout component part list

| Component   | Description                                                        |
|-------------|--------------------------------------------------------------------|
| PCB         | 1/32" woven fiberglass 0.030 Cu, sides, $\epsilon_r = 4.8$         |
| T1          | 50 Ohm flexible coax cable OD 0.06", 3" long. ferrite core NEOSIDE |
| T2, T3      | 9:1 transformer, 16.5 Ohm flexible coax cable 0.1", 3" long        |
| T4, T5      | 4:1 transformer, 25 Ohm flexible coax cable OD 0.06", 5" long      |
| C1          | 8.2 pF ceramic cap                                                 |
| C2, C3      | 100 pF ceramic cap                                                 |
| C4          | 2 - 18 pF chip cap                                                 |
| C5          | 47 pF ceramic cap                                                  |
| C6, C11     | 47 nF ceramic cap                                                  |
| C7          | 56 pF ATC chip cap                                                 |
| C8, C9, C13 | 470 pF ATC chip cap                                                |
| C10         | 100 nF ceramic cap                                                 |
| C12         | 2 x 330 nF / 50 V cap                                              |
| C14         | 10 nF / 63 V electrolytic cap                                      |
| R1, R3      | 47 Ohm resistor                                                    |
| R2          | 6.8 kOhm chip resistor                                             |
| R4          | 4.7 kOhm multi turn trim resistor                                  |
| R5          | 8.2 kOhm / 5 W resistor                                            |
| R6          | 3.3 kOhm / 5 W resistor                                            |
| D1          | 6.8 V Zener diode                                                  |
| L1          | 20 nH inductor                                                     |
| L2          | 70 nH inductor                                                     |
| L3          | 30 nH inductor                                                     |
| L4          | 10 nH inductor                                                     |
| L5          | 15 nH inductor                                                     |

## 9 Typical broadband data (88 - 108 MHz)

Figure 25: Input power vs. frequency ( $P_{OUT}=300$ )Figure 26: Power gain vs. frequency ( $P_{OUT}=300$ )Figure 27: Efficiency vs. frequency ( $P_{OUT}=300$ )Figure 28: Return loss vs. frequency ( $P_{OUT}=300$ )Figure 29: 2<sup>nd</sup> harmonic vs. frequency (88 - 108 MHz)Figure 30: 3<sup>rd</sup> harmonic vs. frequency (88 - 108 MHz)

## 10 Test circuit 88-108 MHz

Figure 31: 88 - 108 MHz test circuit layout (engineering fixture)

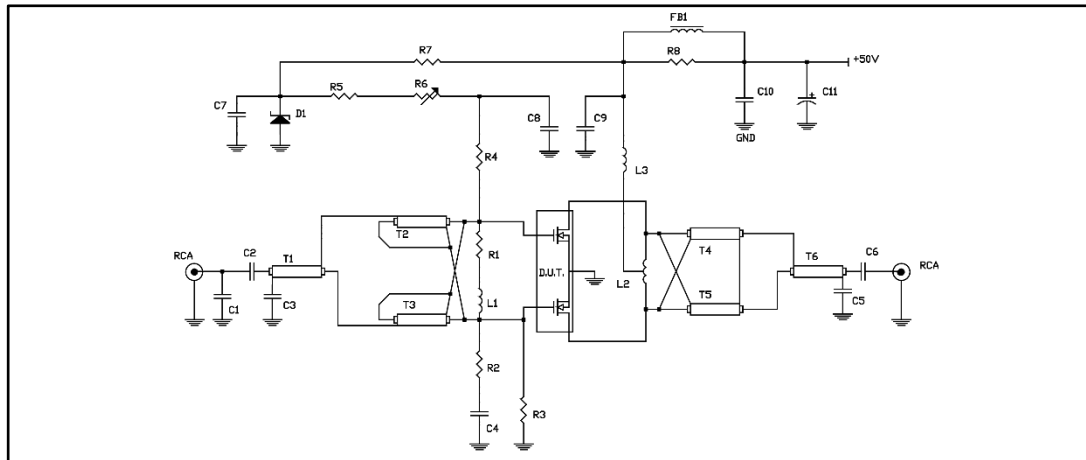


Table 9: 88 - 108 MHz circuit layout component part list

| Component          | Description                                                                 |
|--------------------|-----------------------------------------------------------------------------|
| PCB                | 1/32" woven fiberglass 0.030 Cu, sides, $\epsilon_r = 4.8$                  |
| T1                 | 50 Ohm flexible coax cable OD 0.06", 3" long                                |
| T2, T3             | 9:1 transformer, 25 Ohm flexible coax cable 0.1", 3.9" ferrite core NEOSIDE |
| T4, T5             | 4:1 transformer, 25 Ohm flexible coax cable OD 0.1", 5" long                |
| T6                 | 50 Ohm flexible coax cable OD 0.1", 5" long                                 |
| FB1                | vk200                                                                       |
| C1                 | 10 pF ceramic cap                                                           |
| C2, C3, C4, C7, C8 | 1 nF chip cap                                                               |
| C5, C6             | 1 nF ATC chip cap                                                           |
| C9                 | 470 pF ceramic cap                                                          |
| C10                | 100 nF chip cap                                                             |
| C11                | 100 mF / 63 V electrolytic cap                                              |
| R1                 | 56 Ohm resistor                                                             |
| R2, R4             | 10 Ohm chip resistor                                                        |
| R3                 | 10 kOhm resistor                                                            |
| R5                 | 5.6 Ohm resistor                                                            |
| R6                 | 10 kOhm, 10 turn trim resistor                                              |
| R7                 | 3.3 kOhm / 5 W resistor                                                     |
| R8                 | 15 Ohm / 5 W resistor                                                       |
| D1                 | 6.8 V Zener diode                                                           |
| L1                 | 10 nH inductor                                                              |
| L2                 | 40 nH inductor                                                              |
| L3                 | 70 nH inductor                                                              |

## 11 Marking, packing and shipping specifications

Table 10: Packing and shipping specifications

| Order code | Packing | Pieces per tray | Dry pack humidity | V <sub>GS</sub> and G <sub>FS</sub> code | Lot code  |
|------------|---------|-----------------|-------------------|------------------------------------------|-----------|
| SD2932W    | Tube    | 15              | < 10%             | Not mixed                                | Not mixed |

Figure 32: SD2932 marking layout

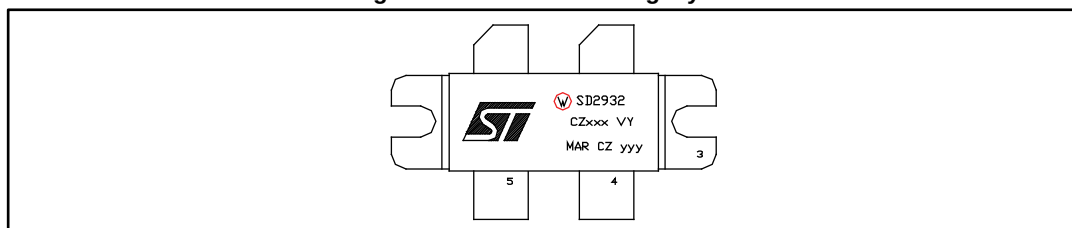


Table 11: Marking specifications

| Symbol | Description                    |
|--------|--------------------------------|
| W      | Wafer process code             |
| CZ     | Assembly plant                 |
| xxx    | Last 3 digits of diffusion lot |
| VY     | Diffusion plant                |
| MAR    | Country of origin              |
| CZ     | Test and finishing plant       |
| y      | Assembly year                  |
| yy     | Assembly week                  |

## 12 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 12.1 M244 package information

Figure 33: M244 (0.400 x .860 4L BAL N/HERM W/FLG) package outline

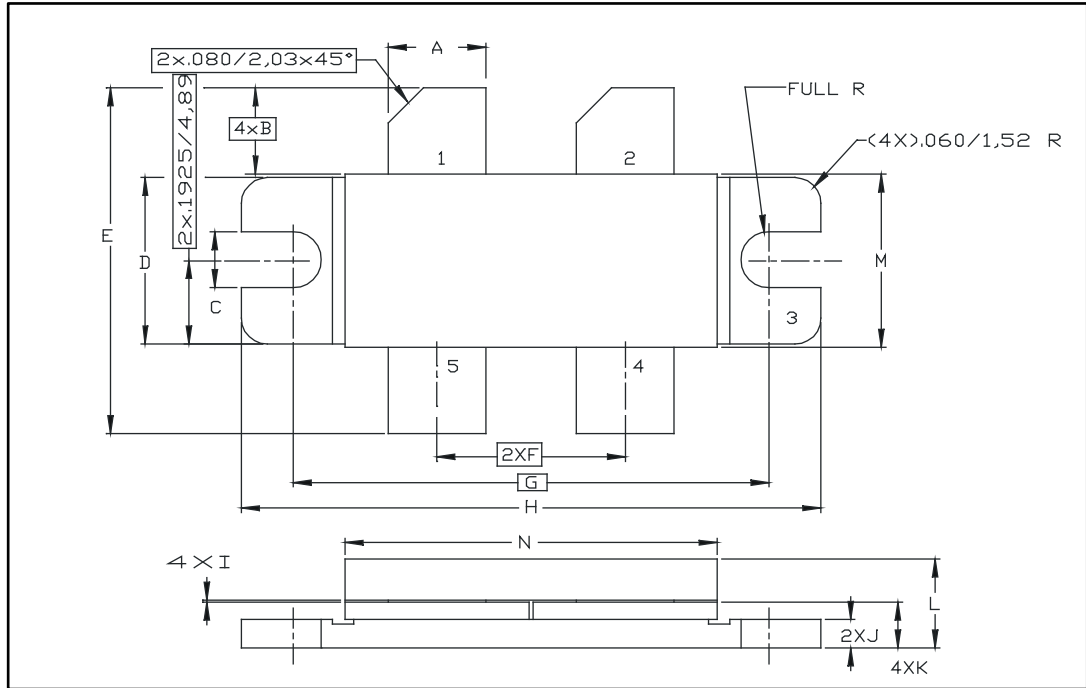


Table 12: M244 (0.400 x .860 4L BAL N/HERM W/FLG) package mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 5.59  |       | 5.84  |
| B    |       | 5.08  |       |
| C    | 3.02  |       | 3.28  |
| D    | 9.65  |       | 9.91  |
| E    | 19.81 |       | 20.82 |
| F    | 10.92 |       | 11.18 |
| G    |       | 27.94 |       |
| H    | 33.91 |       | 34.16 |
| I    | 0.10  |       | 0.15  |
| J    | 1.52  |       | 1.78  |
| K    | 2.59  |       | 2.84  |
| L    | 4.83  |       | 5.84  |
| M    | 10.03 |       | 10.34 |
| N    | 21.59 |       | 22.10 |

## 13 Revision history

Table 13: Document revision history

| Date        | Revision | Changes                                                                                           |
|-------------|----------|---------------------------------------------------------------------------------------------------|
| 15-Jul-2004 | 5        |                                                                                                   |
| 24-Jan-2006 | 6        | Updated <i>Table 4: Static (per section)</i> .                                                    |
| 23-Nov-2009 | 7        | Inserted $\Delta_{VGS}$ in <i>Table 4: Static (per section)</i> .                                 |
| 31-Mar-2010 | 8        | Added <i>Figure 7, Figure 8 and Figure 9</i> .                                                    |
| 11-Jan-2012 | 9        | Inserted <i>Chapter 12: Marking, packing and shipping specifications</i> .<br>Minor text changes. |
| 24-Nov-2016 | 10       | Updated <a href="#">Section 1.1: "Maximum ratings"</a> .                                          |

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